

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:

NEW ASSIGNMENT

NATURE OF CONVEYANCE:

ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hwan Seok PARK	01/16/2009
Young Sub JIN	01/16/2009
Jae Keun HONG	01/16/2009
Sung Kwan KIM	01/16/2009
Byeong Do LEE	01/16/2009
Ho Ryong SUN	01/16/2009
Seung Dae LEE	01/16/2009

RECEIVING PARTY DATA

Name:	Cheil Industries Inc.
Street Address:	290 Gongdan-dong
Internal Address:	Gumi-si
City:	Gyeongsangbuk-do
State/Country:	REPUBLIC OF KOREA
Postal Code:	730-710

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12344703

CORRESPONDENCE DATA

Fax Number: (704)945-6735

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 704-945-6700

Email: rowens@summalaw.com

Correspondent Name: Melissa B. Pendleton

Address Line 1: 11610 N. Community House Road

Address Line 2: Suite 200

Address Line 4: Charlotte, NORTH CAROLINA 28277

OP \$40.00 12344703

PATENT

500772841

REEL: 022209 FRAME: 0885

ATTORNEY DOCKET NUMBER:	6250.094
NAME OF SUBMITTER:	Melissa b. Pendleton
<p>Total Attachments: 5</p> <p>source=AssignmentsUSPTO#page1.tif</p> <p>source=AssignmentsUSPTO#page2.tif</p> <p>source=AssignmentsUSPTO#page3.tif</p> <p>source=AssignmentsUSPTO#page4.tif</p> <p>source=AssignmentsUSPTO#page5.tif</p>	

RECORDATION FORM COVER SHEET
PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

- 1) Hwan Seok PARK 6) Ho Ryong SUN
2) Young Sub JIN 7) Seung Dae LEE
3) Jae Keun HONG
4) Sung Kwan KIM
5) Byeong Do LEE

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) 01/16/2009

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other _____

2. Name and address of receiving party(ies)

Name: Cheil Industries Inc.

Internal Address: _____

Street Address: 290 Gongdan-dong

City: Gumi-si

State: Gyeongsangbuk-do

Country: South Korea Zip: 730-710

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☐ This document is being filed together with a new application.
A. Patent Application No.(s)
B. Patent No.(s)

12/344,703

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Summa, Additon & Ashe, P.A.

Internal Address: _____

Street Address: 11610 N. Community House
Road, Suite 200

City: Charlotte

State: NC Zip: 28277-2199

Phone Number: 704-945-6700

Fax Number: 704-945-6735

Email Address: _____

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☒ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number _____

Authorized User Name _____

9. Signature: /Melissa B. Pendleton/

February 5, 2009

Melissa B. Pendleton

Signature

Date

Name of Person Signing

Total number of pages including cover
sheet, attachments, and documents:

5

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT

WHEREAS, I, **Hwan Seok PARK**, a citizen of the Republic of Korea, residing at 604-411, Saetbyeol Hanyang Apt. 1109, Bisan-dong, Dongan-gu, Anyang-si, Gyeonggi-do, Republic of Korea; **Young Sub JIN**, a citizen of the Republic of Korea, residing at 519-1901, Byucksan 5 Danji Apt., Siheung2-Dong, Geumcheon-gu, Seoul, Republic of Korea; **Jae Keun HONG**, a citizen of the Republic of Korea, residing at 210-1203, Jugong2cha Apt., Dang-Dong, Gunpo-Si, Gyeonggi-Do, Republic of Korea; **Sung Kwan KIM**, a citizen of the Republic of Korea, residing at #101, 775-1, Dang-Dong, Gunpo-Si, Gyeonggi-Do, Republic of Korea; **Byeong Do LEE**, a citizen of the Republic of Korea, residing at 102-807, More town Apt., 927-2, Hwajung4-Dong, Seo-Gu, Gwangju, Republic of Korea; **Ho Ryong SUN**, a citizen of the Republic of Korea, residing at # 207 Cheil Industries Company House, 90 Singi-dong, Yeosu-si, Jeollanam-do, Republic of Korea; and **Seung Dae LEE**, a citizen of the Republic of Korea, residing at 108-1003, Buyoung1cha Apt., Yeonhyang-Dong, Suncheon-si, Jeollanam-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in *Non-Glossy Rubber Modified Aromatic Vinyl-Vinyl Cyanide Copolymer and Method for Continuously Preparing the Same*, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from Korean Patent Application No. 2007-141056, filed December 28, 2007, and Korean Application No. 2008-108621, filed November 3, 2008, all applications

listed above being hereinafter referred to as the
"APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation, having a principal place of business at 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730-710, Republic of Korea, (hereinafter referred to as "ASSIGNEE") has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest—and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest—in and to said INVENTION and APPLICATION, in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as

fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

1. 16, 2009

박 환석
Hwan Seok PARK

1. 16, 2009

지 영 섭
Young Sub JIN

1. 16, 2009

홍 재근
Jae Keun HONG

Jan 16, 2009

김 광 안
Sung Kwan KIM

Jan. 16., 2009

이 병 도
Byeong Do LEE

Jan. 16, 2009

호 령 승
Ho Ryong SUN

Jan. 16, 2009

이 승 대
Seung Dae LEE

S:\FIRM DOCS\6250\094\ASSIGNMENT 6250.094.doc